

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

May 7, 2007

In re the application of:

S. Panda et al.

Docket No. 175P012

Filed: 11/25/2003

Art Unit: 1765

Serial No.: 10/721,657

Examiner: Lan Vinh

For: Method of Processing Wafers With  
Resonant Heating

Confirmation No. 7420

**REPLY TO NON-FINAL OFFICE ACTION**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the non-final Office Action dated February 5, 2007 and identified as Paper No. 20070130, please consider the following remarks.

**Remarks/Arguments** begin on page 2 of this paper.